



DMC4050SSD

40V COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

			I _D Max
Device	V _{(BR)DSS}	R _{DS(ON)} Max	T _A = +25°C
			(Notes 6 & 8)
Q1	40V	45mΩ @ V _{GS} = 10V	5.5A
QI	40 V	60mΩ @ V _{GS} = 4.5V	4.2A
Q2	40\/	45mΩ @ V _{GS} = -10V	-5.8A
	-40V	60mΩ @ V _{GS} = -4.5V	-4.2A

Description and Applications

This MOSFET is designed to ensure that $R_{DS(ON)}$ of N and P channel FET are matched to minimize losses in both arms of the bridge. The DMC4040SSD is optimized for use in 3-phase brushless DC motor circuits (BLDC), and CCFL backlighting.

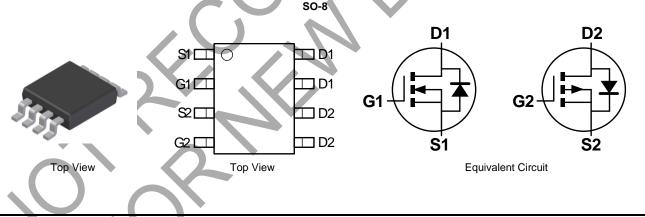
- 3-Phase BLDC Motor
- CCFL Backlighting

Features and Benefits

- Matched N & P R_{DS(ON)} Minimizes Power Losses
- Fast Switching Minimizes Switching Losses
- Dual Device Reduces PCB Area
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotiveproducts/.
- This part is qualified to JEDEC standards (as referenced in AEC-Q) for High Reliability.
- https://www.diodes.com/guality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMC4055SSDQ)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Ordering Information (Note 4)

Product	Case	Packaging			
DMC4050SSD-13	SO-8	2500/Tape & Reel			
Notes: 1 No purposely added lead Fully FLI Directive 2002/05/FC (RoHS) 2011/65/FLI (RoHS 2) & 2015/863/FLI (RoHS 3) compliant					

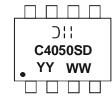
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



C4050SD = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 20 = 2020) WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	N-Channel - Q1	P-Channel - Q2	Units
Drain-Source Voltage		V _{DSS}	40	-40	V	
Gate-Source Voltage		V _{GSS}	±20	±20	V	
		(Notes 6 & 8)		5.8	-5.8	
Continuous Drain Current	$V_{GS} = 10V$	T _A = +70°C (Notes 6 & 8)	- 10 -	4.38	-4.52	
		(Notes 5 & 8)		4.2	-4.2	
		(Notes 5 & 9)		5.3	-5.3	А
Pulsed Drain Current	$V_{GS} = 10V$	(Notes 7 & 8)	IDM	24.1	-24.9	
Continuous Source Current	(Body Diode)	(Notes 6 & 8)	ls	2.5	-2.5	
Pulsed Source Current (Bod	y Diode)	(Notes 7 & 8)	I _{SM}	24.1	-24.9	

Thermal Characteristics

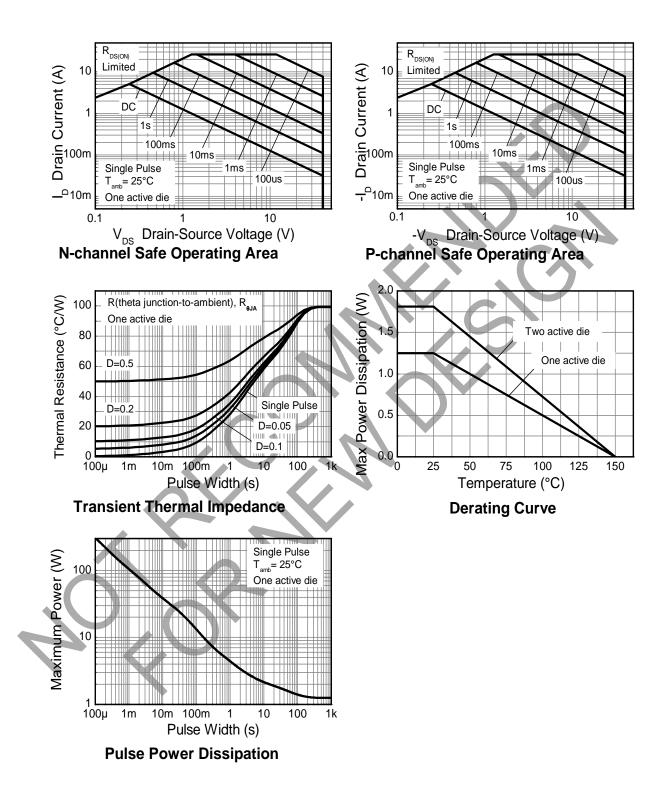
Characteristic		Symbol	Value	Unit	
Power Dissipation	(Notes 5 & 8)		1.25	W	
Linear Derating Factor	(Notes 5 & 9)	PD	1.8	mW/°C	
	(Notes 6 & 8)		2.14	IIIW/ C	
	(Notes 5 & 8)		100		
Thermal Resistance, Junction to Ambient	(Notes 5 & 9)	R _{0JA}	70	9 0 AA/	
	(Notes 6 & 8)		58	°C/W	
Thermal Resistance, Junction to Lead	(Notes 5 & 10)	R _{θJL}	51		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

 5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
6. Same as note (5), except the device is measured at t ≤ 10 sec.
7. Same as note (5), except the device is pulsed with D = 0.02 and pulse width 300µs.
8. For a dual device with one active die. Notes:

For a device with two active die running at equal power.
Thermal resistance from junction to solder-point (at the end of the drain lead).



Thermal Characteristics (continued)





Electrical Characteristics (Q1 N-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 11)	Cymbol		196	Mux	Unit	
Drain-Source Breakdown Voltage	BV _{DSS}	40			V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_		1.0	μA	$V_{DS} = 40V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 11)						
Gate Threshold Voltage	V _{GS(th)}	0.8	1.3	1.8	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}	—	20 33	45 60	mΩ	$V_{GS} = 10V, I_D = 3A$ $V_{GS} = 4.5V, I_D = 3A$
Forward Transfer Admittance	Y _{fs}	_	12.6		S	$V_{DS} = 5V, I_D = 3A$
Diode Forward Voltage (Note 11)	V _{SD}	_	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 12)						
Input Capacitance	Ciss	—	1790.8	—	pF	
Output Capacitance	C _{oss}	—	160.6	-	pF	−V _{DS} = 20V, V _{GS} = 0V, −f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	—	120.5	_	pF	
Gate Resistance	Rg	—	1.03		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	_	37.56	1	nC	
Gate-Source Charge	Q _{gs}	—	7.8		nC	$V_{GS} = 10V, V_{DS} = 20V,$
Gate-Drain Charge	Q _{gd}	—	6.6	-	nC	$-I_D = 3A$
Turn-On Delay Time	t _{D(on)}	_	8.08	<u> </u>	nS	
Turn-On Rise Time	tr	-	15.14	—	nS	$V_{GS} = 10V, V_{DS} = 20V,$
Turn-Off Delay Time	t _{D(off)}	—	24.29	—	nS	$I_D = 3A$
Turn-Off Fall Time	tr	-1	5.27		nS	•
			<			

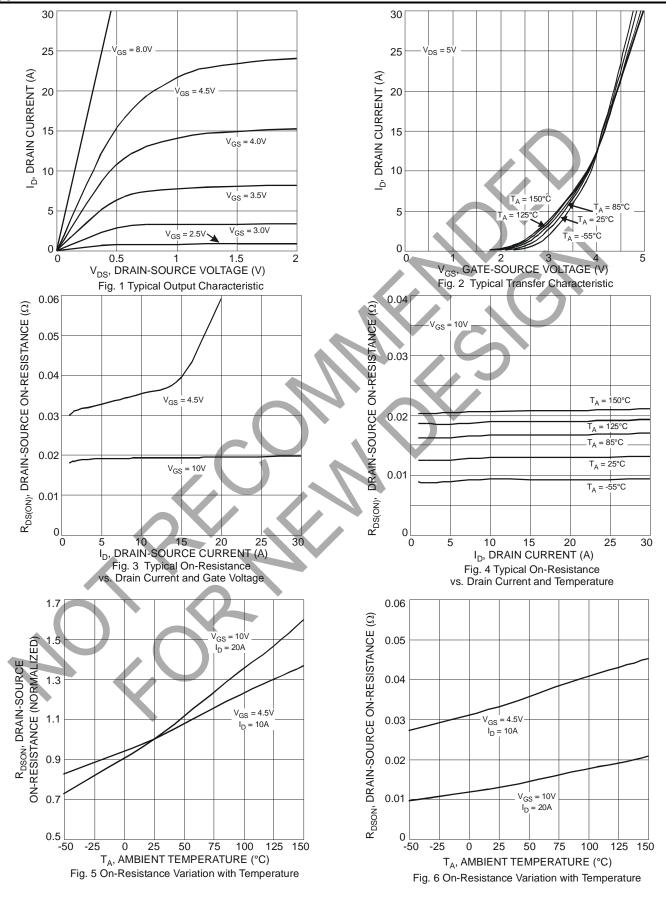
Electrical Characteristics (Q2 P-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic		Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 11)							
Drain-Source Breakdown Voltage		-40	_	_	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}		—	-1.0	μA	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	—	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 11)					•	·	
Gate Threshold Voltage	V _{GS(th)}	-0.8	-1.3	-1.8	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Statia Drain Source On Registeres			28 45	45	45 60 mΩ	$V_{GS} = -10V, I_D = -3A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	30	60		$V_{GS} = -4.5V, I_D = -3A$	
Forward Transfer Admittance		_	16.6	_	S	V _{DS} = -5V, I _D = -3A	
Diode Forward Voltage (Note 11)	V _{SD}	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 12)							
Input Capacitance	Ciss		1643.17	_	pF		
Output Capacitance	Coss		179.13		pF	[−] V _{DS} = -20V, V _{GS} = 0V, −f = 1.0MHz	
Reverse Transfer Capacitance	Crss	—	127.82	_	pF	1 = 1.0MH2	
Gate Resistance	Rq	_	6.43		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qq	_	33.66	_	nC		
Gate-Source Charge	Q _{gs}		5.54		nC	$V_{GS} = -10V, V_{DS} = -20V,$	
Gate-Drain Charge	Q _{ad}		7.30		nC	$-I_D = -3A$	
Turn-On Delay Time	t _{D(on)}		6.85		nS		
Turn-On Rise Time	tr	_	14.72	_	nS	$V_{GS} = -10V, V_{DS} = -20V,$	
Turn-Off Delay Time	t _{D(off)}		53.65		nS	I _D = -3A	
Turn-Off Fall Time	t _f	_	30.86		nS	7	

 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing. Notes:

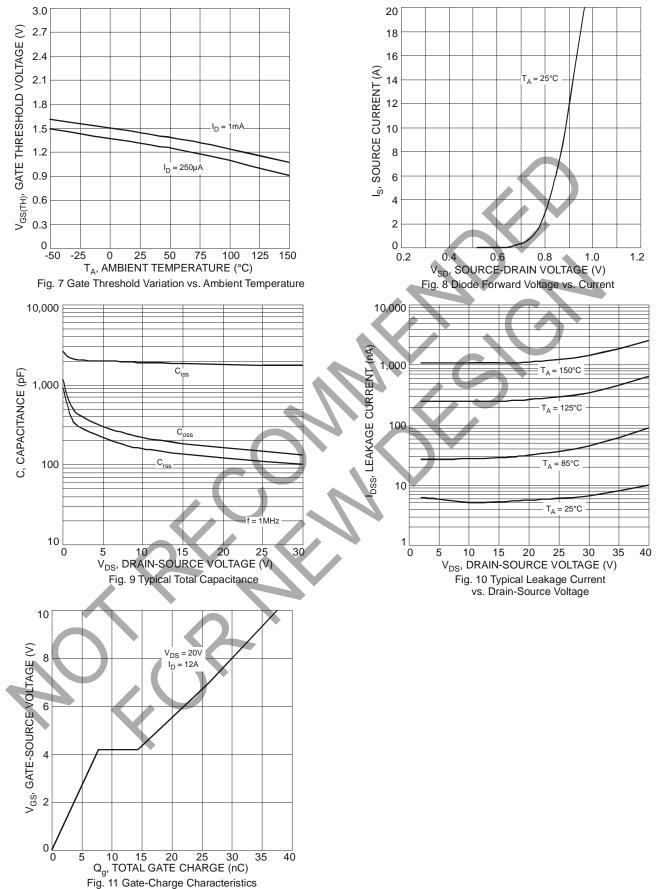


Typical Characteristics (Q1 N-Channel)

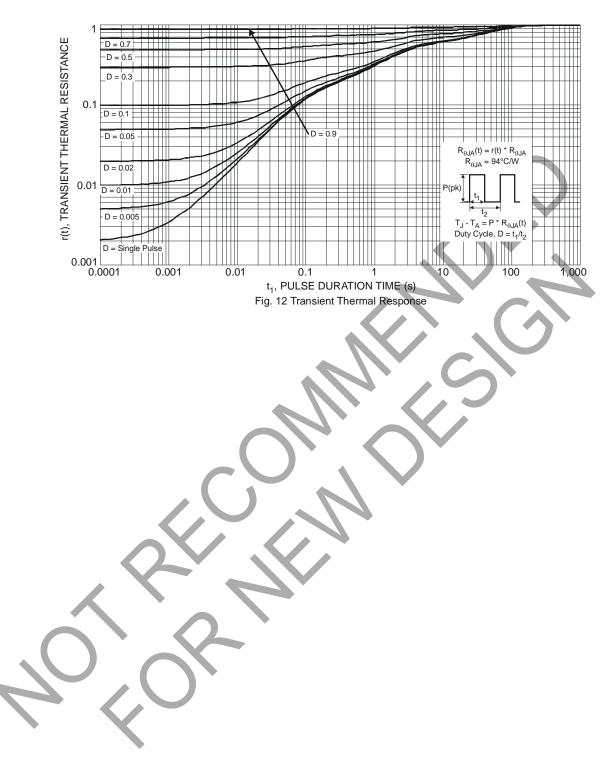




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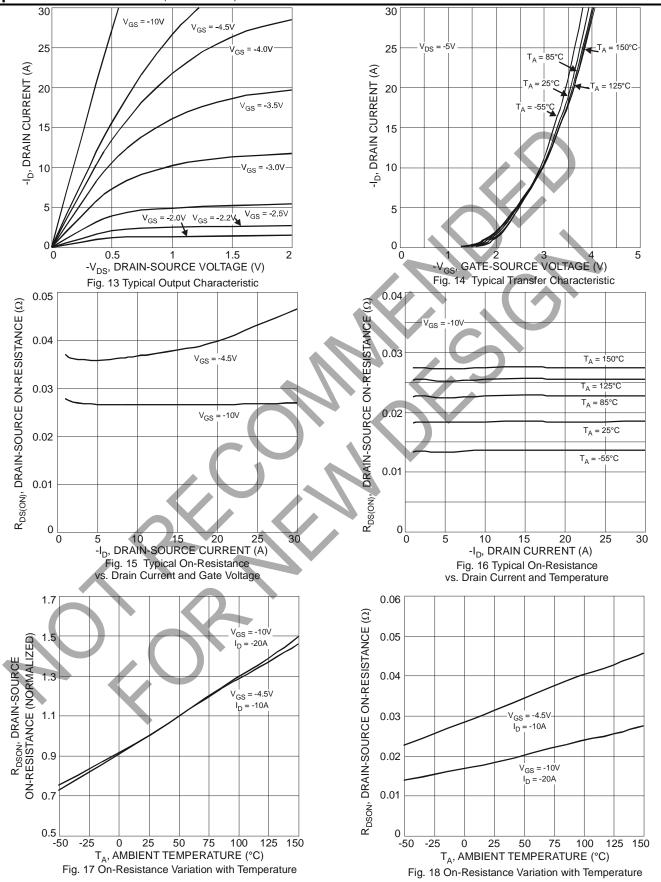






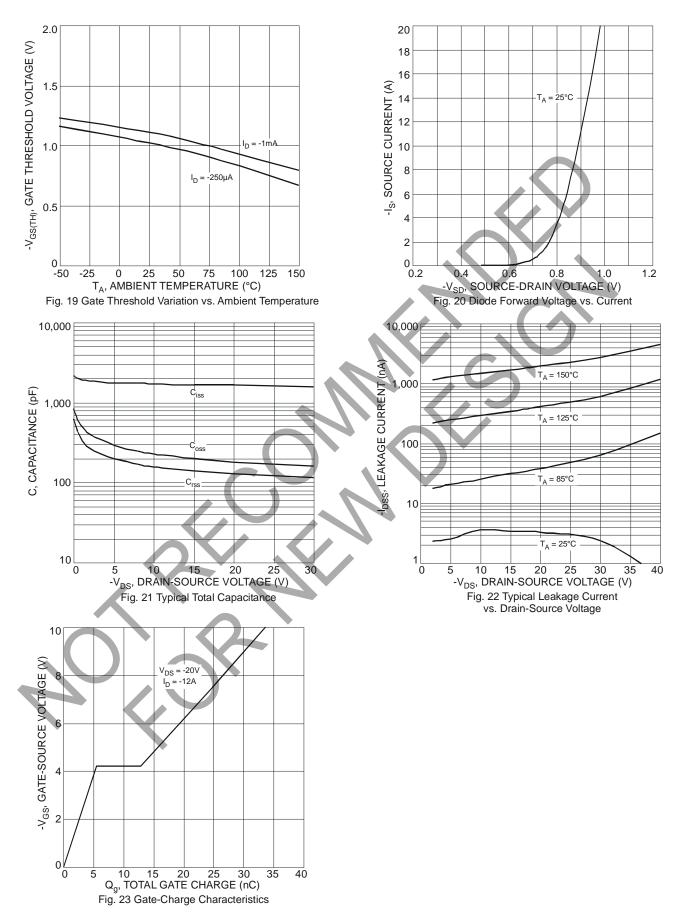


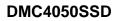
Typical Characteristics (Q2 P-Channel)



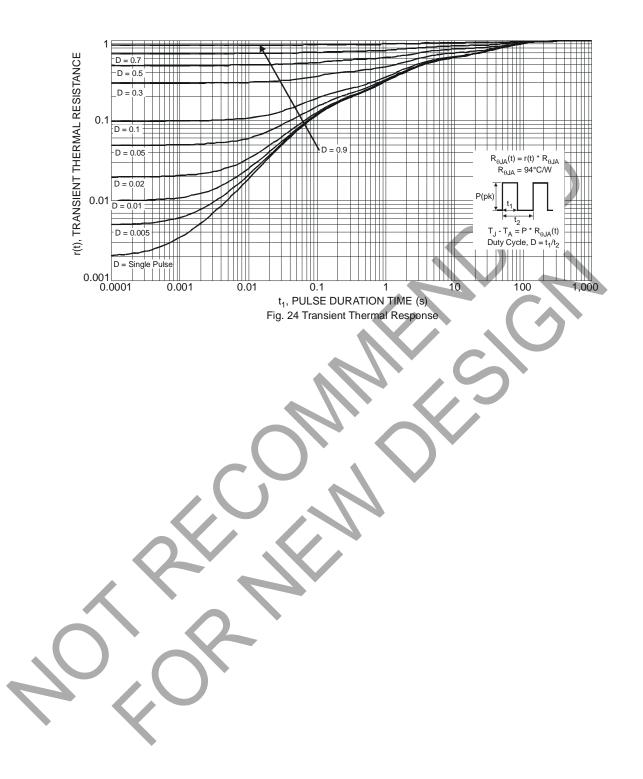


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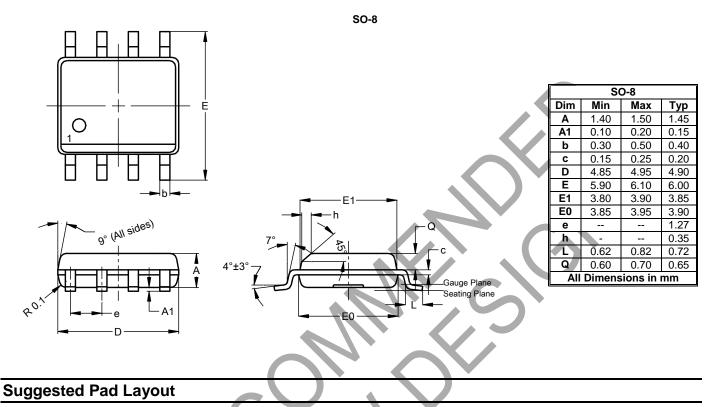




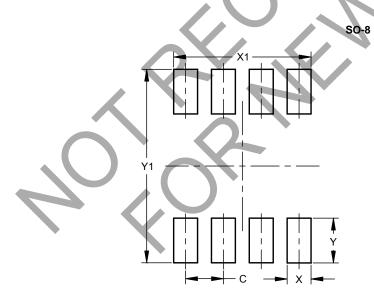


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



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Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



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